

## ■ General Description

The AME8502 family allows the user to customize the CPU reset function without any external components. The user has a large choice of reset voltage thresholds, reset time intervals, and output driver configurations, all of which are preset at the factory. Each wafer is trimmed to the customers specifications.

These circuits monitor the power supply voltage of μP based system. When the power supply voltage drops below the voltage threshold a reset is asserted immediately (within an interval  $T_{D1}$ ). The reset remains asserted after the supply voltage rises above the voltage threshold for a time interval,  $T_{D2}$ . The reset output may be either active high (RESET) or active low (RESETB). The reset output may be configured as push-pull. The state of the reset output is guaranteed to be correct for supply voltages greater than 0.9V.

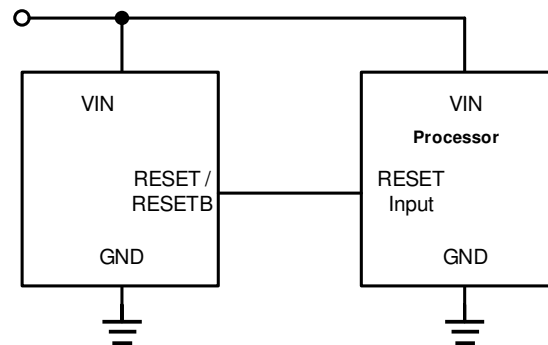
## ■ Features

- Internally Fixed Threshold 1.2V to 4.5V in 0.1V Step
- High Accuracy  $\pm 1.5\%$
- Low Supply Current 3μA
- No External Components Required
- Quick Reset within 20μs
- Built-in Recovery Delay Include 0ms, 55ms, 220ms, 450ms
- Low Functional Supply Voltage 0.9V
- Push-Pull Output
- Small SOT-23, TSOT-23A, SOT-143, SC-70-4, SOT-25 and TSOT-25A Package
- RoHS Compliant and Halogen Free

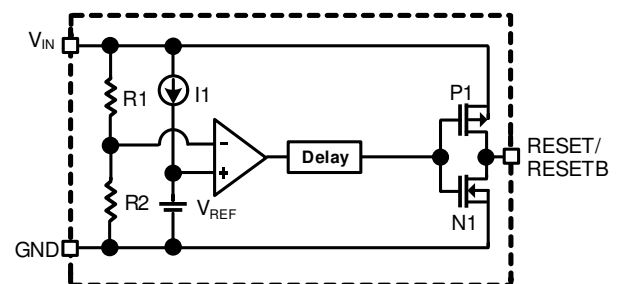
## ■ Application

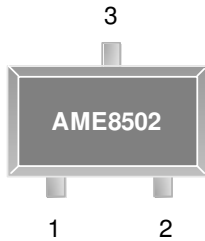
- Portable Electronics
- Power Supplies
- Computer Peripherals
- Data Acquisition Systems
- Applications using CPUs
- Consumer Electronics

## ■ Typical Application



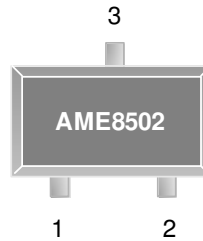
## ■ Functional Block Diagram



**■ Pin Configuration**
**SOT-23/TSOT-23A  
Top View**

**AME8502-AETxxxxxx**

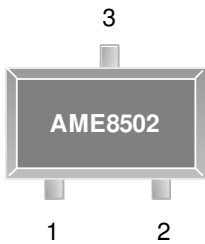
1. GND
2. RESET/RESETB
3. IN

**\* Die Attach:  
Non-Conductive Epoxy**

**SOT-23/TSOT-23A  
Top View**

**AME8502-BETxxxxxx**

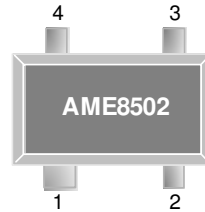
1. RESET/RESETB
2. GND
3. IN

**\* Die Attach:  
Non-Conductive Epoxy**

**SOT-23/TSOT-23A  
Top View**

**AME8502-CETxxxxxx**

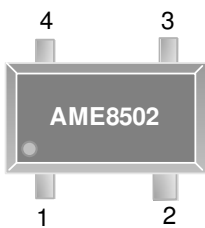
1. RESET/RESETB
2. IN
3. GND

**\* Die Attach:  
Conductive Epoxy**

**SOT-143  
Top View**

**AME8502-A4Uxxxxxx**

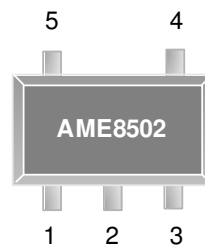
1. GND
2. RESET/RESETB
3. NC
4. IN

**\* Die Attach:  
Conductive Epoxy**

**SC-70-4  
Top View**

**AME8502-AIUxxxxxx**

1. GND
2. RESET/RESETB
3. NC
4. IN

**\* Die Attach:  
Non-Conductive Epoxy**

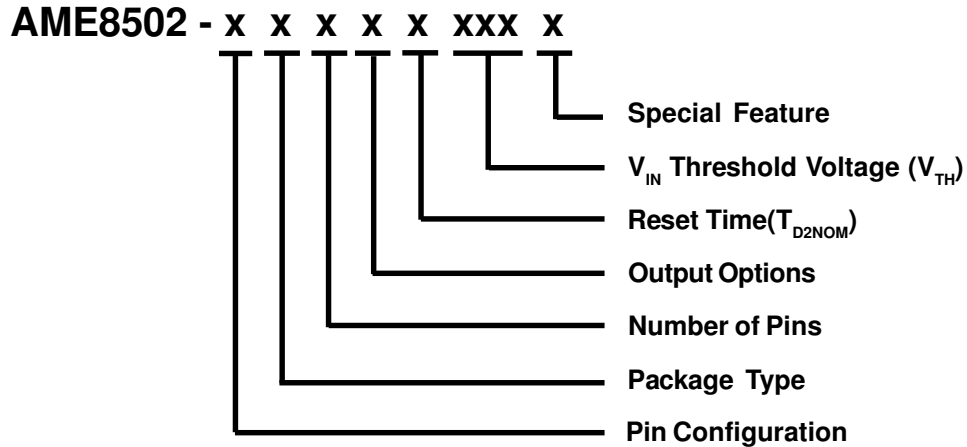
**SOT-25/TSOT-25A  
Top View**

**AME8502-AEVxxxxxx**

1. RESET/RESETB
2. IN
3. GND
4. NC
5. NC

**\* Die Attach:  
Non-Conductive Epoxy**

**■ Pin Description**

Pin No.						Pin Name	Pin Description
SOT-23 / TSOT-23A			SOT-143	SC-70-4	SOT-25 / TSOT-25A		
A	B	C					
1	2	3	1	1	3	GND	Ground.
2	1	1	2	2	1	RESET/ RESETB	This pin can be ordered as RESET or RESETB. Reset is active high. RESETB is active low. It is also available with a push-pull.
3	3	2	4	4	2	IN	Positive power supply. A reset is asserted after this voltage drops below a predetermined level. After $V_{IN}$ rises above that level the reset output remains asserted until the end of the reset timeout period.
N/A	N/A	N/A	3	3	4, 5	NC	No connection. Not internally connected. Can left floating or connected to GND.

**■ Ordering Information**


Pin Configuration	Package Type	Number of Pins	Output Options	Reset Time ( $T_{D2NOM}$ )	$V_{IN}$ Threshold Voltage ( $V_{TH}$ )	Special Feature
<b>A</b> 1. GND (SOT-23) 2. RESET/RESETB (TSOT-23A) 3. IN	E: SOT-2X I: SC-70 4: SOT-143	T: 3 U: 4 V: 5	A: RESETB B: RESET	B: 0ms C: 55ms D: 220ms G: 450ms	120: 1.2V 130: 1.3V 140: 1.4V : : : : : : 480: 4.8V 490: 4.9V 500: 5.0V	N/A: SOT-23/SOT-25 K: 0.9mm max (for TSOT-2XA Only)
<b>B</b> 1. RESET/RESETB (SOT-23) 2. GND (TSOT-23A) 3. IN						
<b>C</b> 1. RESET/RESETB (SOT-23) 2. IN (TSOT-23A) 3. GND						
<b>A</b> (SOT-143) 1. GND 2. RESET/RESETB 3. NC 4. IN						
<b>A</b> (SC-70-4) 1. GND 2. RESET/RESETB 3. NC 4. IN						
<b>A</b> (SOT-25) 1. RESET/RESETB (TSOT-25A) 2. IN 3. GND 4. NC 5. NC						

**■ Absolute Maximum Ratings**

Parameter		Maximum	Unit
Supply Voltage		6	V
Input Current, $V_{IN}$		20	mA
Output Current, RESET, RESETB		20	mA
ESD Classification	HBM	2	kV
	MM	200	V

**■ Recommended Operating Conditions**

Parameter	Symbol	Rating	Unit
Junction Temperature Range	$T_J$	-40 to +125	°C
Ambient Temperature Range	$T_A$	-40 to +85	
Storage Temperature Range	$T_{STG}$	-65 to +150	

**■ Thermal Information**

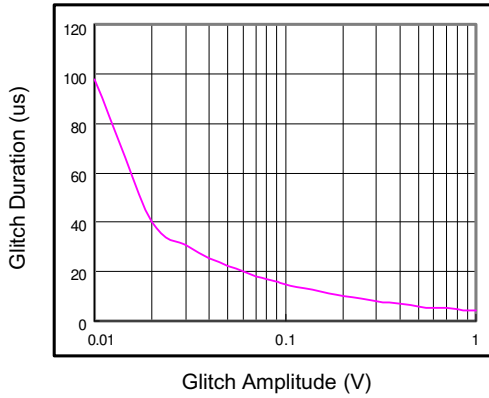
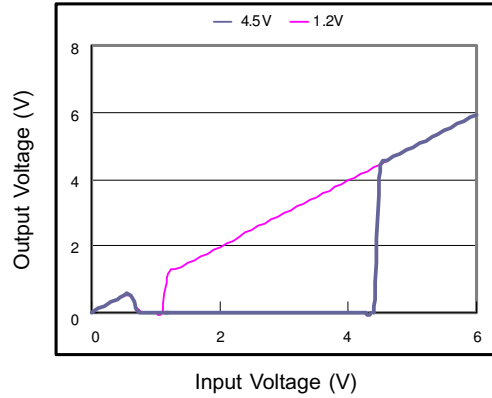
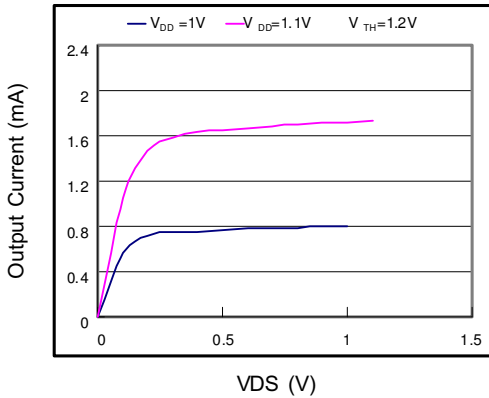
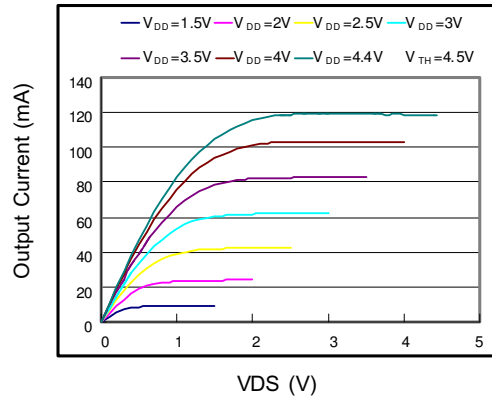
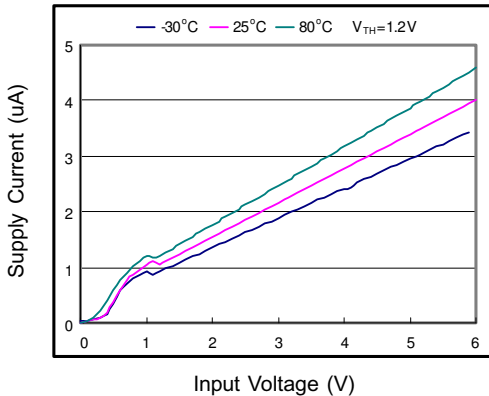
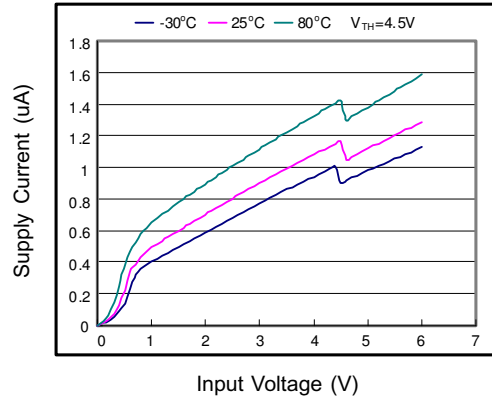
Parameter	Package	Die Attach	Symbol	Maximum	Unit
Thermal Resistance* (Junction to Case)	SOT-23 TSOT-23A	Conductive Epoxy	$\theta_{JC}$	81	°C / W
	SOT-143			130	
	SOT-23 SOT-25	Non-Conductive Epoxy		140	
	TSOT-23A TSOT-25A			130	
	SC-70-4			120	
Thermal Resistance (Junction to Ambient)	SOT-23	Conductive Epoxy	$\theta_{JA}$	260	°C / W
	TSOT-23A			230	
	SOT-143			350	
	SOT-23 SOT-25	Non-Conductive Epoxy		280	
	TSTO-23A TSOT-25A			250	
	SC-70-4			400	
Internal Power Dissipation	SOT-23	Conductive Epoxy	$P_D$	400	mW
	TSOT-23A			455	
	SOT-143			285	
	SOT-23 SOT-25	Non-Conductive Epoxy		400	
	TSTO-23A TSOT-25A			400	
	SC-70-4			300	
Lead Temperature ( soldering 10 sec)**				260	°C

\* Measure  $\theta_{JC}$  on center of molding compound if IC has no tab.

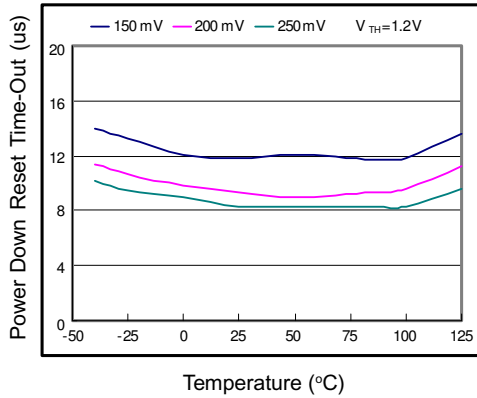
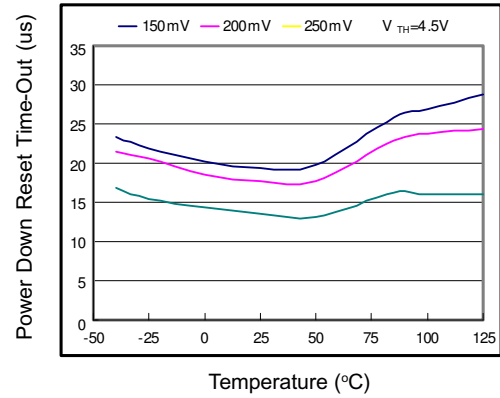
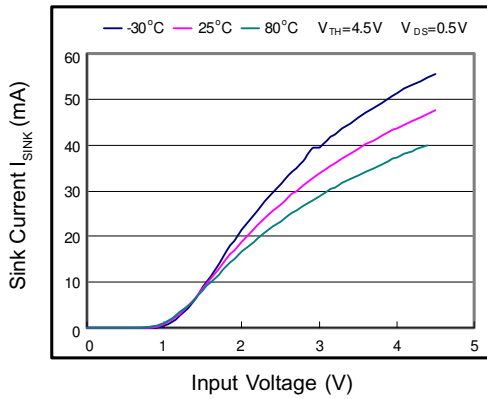
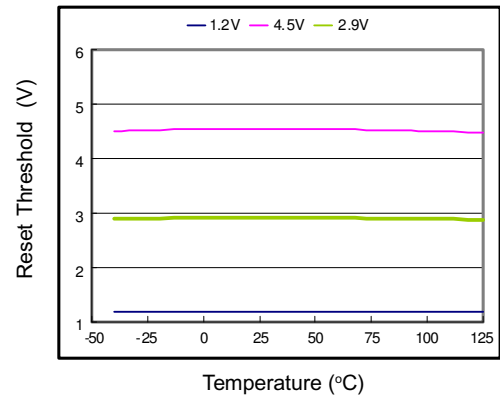
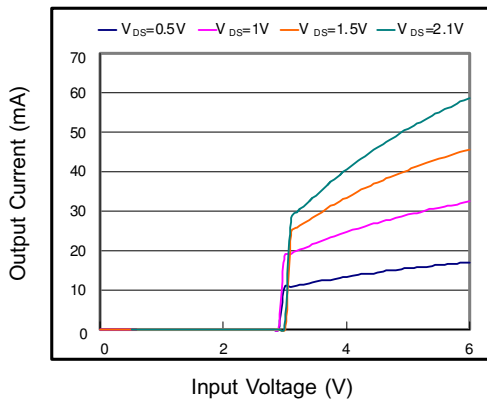
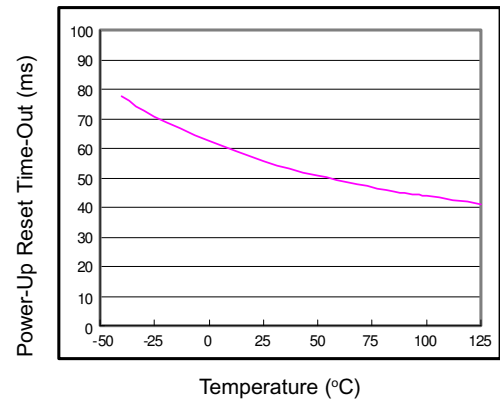
\*\* MIL-STD-202G210F.

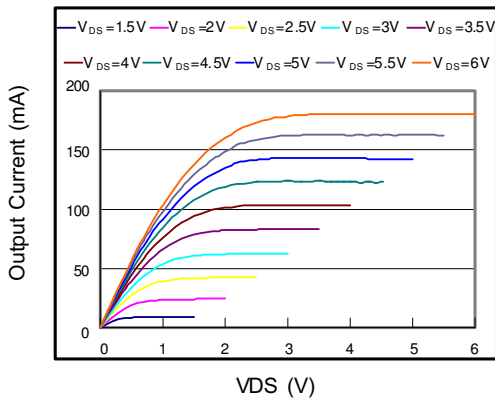
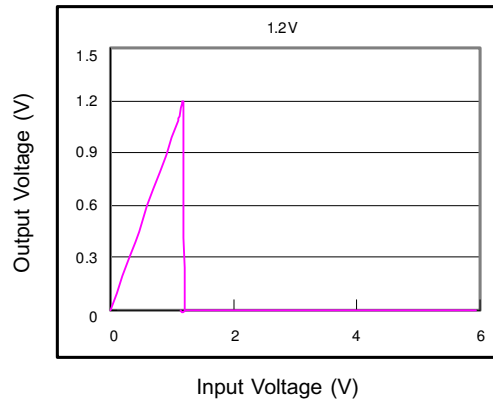
**■ Electrical Specifications**
 $T_A=27^\circ\text{C}$ , unless otherwise specified.

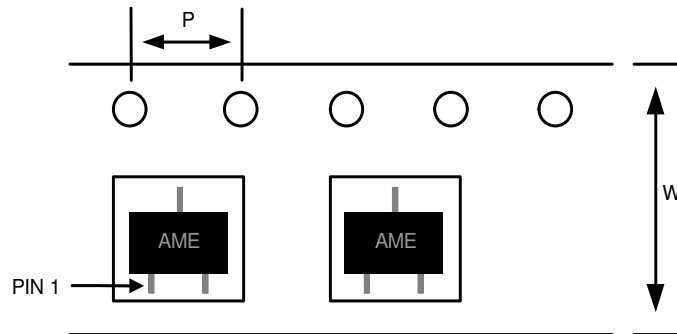
Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Operating $V_{DD}(V_{OUT})$ Range	$V_{DD}$	RESET	0.9		6	V
		RESET	1.1		6	
Supply Current	$I_{DD}$	$V_{DD}=5\text{V}$ , $T_A=27^\circ\text{C}$		3	8	$\mu\text{A}$
Reset Threshold	$V_{TH}$	$T_A=27^\circ\text{C}$		1.2 to 4.5		V
Threshold Voltage Accuracy	$\Delta V_{TH}$	$T_A=27^\circ\text{C}$	-1.5		1.5	%
$V_{DD}$ Drop to Reset Delay	$t_{RD}$	Drop= $V_{TH}-125\text{mV}$		20		$\mu\text{s}$
Reset Active Time Out Period	Version B	$V_{DD} \geq 1.02 \times V_{TH}$	0	0	0	ms
	Version C		35	55	75	
	Version D		143	220	297	
	Version G		292	450	608	
RESET Output Voltage Low	$V_{OL}$	$V_{DD} < V_{TH(MIN)}$ , $I_{SINK}=3.5\text{mA}$ , $V_{TH} \geq 3\text{V}$			0.4	V
		$V_{DD} < V_{TH(MIN)}$ , $I_{SINK}=1.2\text{mA}$ , $V_{TH} \geq 1.8\text{V}$			0.3	
		$V_{TH(MIN)} > V_{DD} > 1\text{V}$ , $I_{SINK}=0.5\text{mA}$			0.3	
RESET Output Voltage High	$V_{OH}$	$V_{DD} > V_{TH(MAX)}$ , $I_{SOURCE}=800\mu\text{A}$ , $V_{TH} \geq 3\text{V}$	$V_{DD}-1.5$			V
		$V_{DD} > V_{TH(MAX)}$ , $I_{SOURCE}=500\mu\text{A}$ , $V_{TH} \geq 1.8\text{V}$	$0.8 V_{DD}$			
		$V_{DD} > V_{TH(MAX)}$ , $I_{SOURCE}=200\mu\text{A}$ , $V_{TH} \geq 1.1\text{V}$	$0.8 V_{DD}$			
RESET Output Voltage Low	$V_{OL}$	$V_{DD} > V_{TH(MAX)}$ , $I_{SINK}=3.5\text{mA}$ , $V_{TH} \geq 3\text{V}$			0.4	V
		$V_{DD} > V_{TH(MAX)}$ , $I_{SINK}=1.2\text{mA}$ , $V_{TH} \geq 1.8\text{V}$			0.3	
		$V_{DD} > V_{TH(MAX)}$ , $I_{SINK}=0.5\text{mA}$ , $V_{TH} \geq 1.2\text{V}$			0.3	
RESET Output Voltage High	$V_{OH}$	$1.1\text{V} < V_{DD} < V_{TH(MIN)}$ , $I_{SOURCE}=200\mu\text{A}$	$0.8 V_{DD}$			V
		$1.8\text{V} < V_{DD} < V_{TH(MIN)}$ , $I_{SOURCE}=500\mu\text{A}$	$0.8 V_{DD}$			
		$3\text{V} < V_{DD} < V_{TH(MIN)}$ , $I_{SOURCE}=800\mu\text{A}$	$V_{DD}-1.5$			
Hysteresis Width	$V_{HYS}$			$0.01V_{TH}$		V

**■ Characterization Curve**
**Glitch Rejection**

**Output Voltage vs. Input Voltage**

**Nch Driver Output Current vs VDS**

**Nch Driver Output Current vs VDS**

**Supply Current vs Input Voltage**

**Supply Current vs Input Voltage**


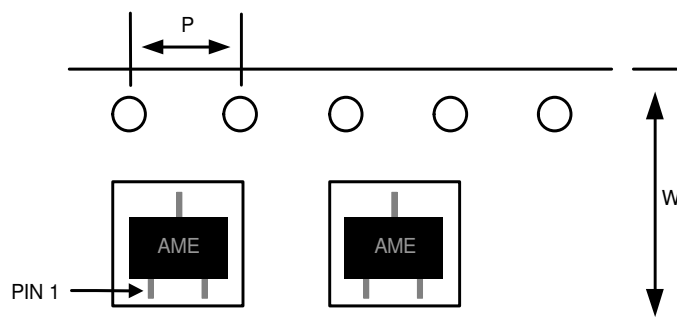


**■ Characterization Curve (Contd.)**
**Power-Down Reset vs. Temperature**

**Power-Down Reset vs. Temperature**

**Nch Driver Sink Current vs. Input Voltage**

**Reset Threshold Derivation vs. Temperature**

**Pch Driver Output Current vs. Input Voltage**

**Power-Up Reset Time-Out vs. Temperature**


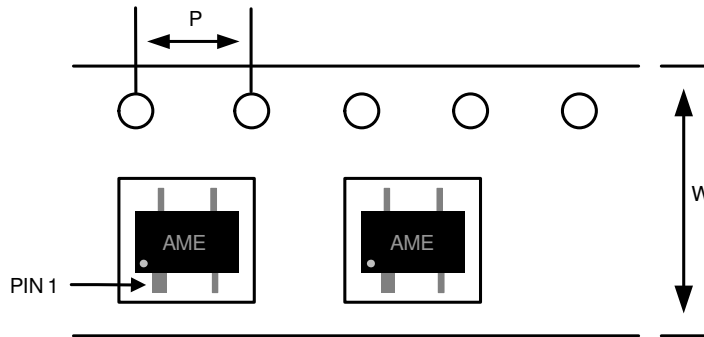
**■ Characterization Curve (Contd.)**
**Nch Driver Output Current vs VDS**

**Output Voltage vs. Input Voltage**


**■ Tape and Reel Dimension**
**SOT-23**

**Carrier Tape, Number of Components Per Reel and Reel Size**

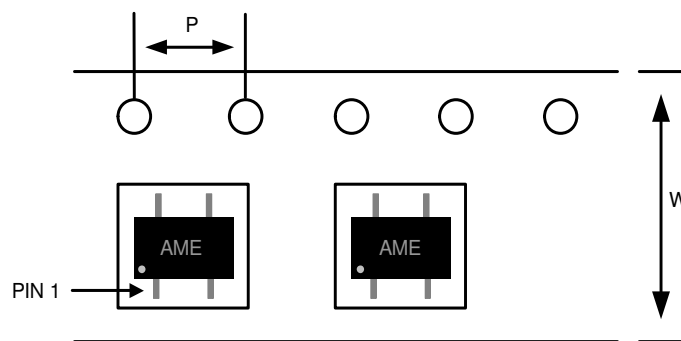
Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
SOT-23	8.0±0.1 mm	4.0±0.1 mm	3000pcs	180±1 mm

**TSOT-23-A**

**Carrier Tape, Number of Components Per Reel and Reel Size**

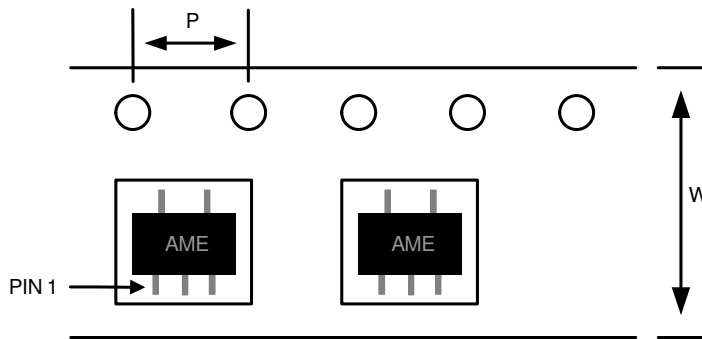
Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
TSOT-23A	8.0±0.1 mm	4.0±0.1 mm	3000pcs	180±1 mm

**■ Tape and Reel Dimension (Contd.)**
**SOT-143**

**Carrier Tape, Number of Components Per Reel and Reel Size**

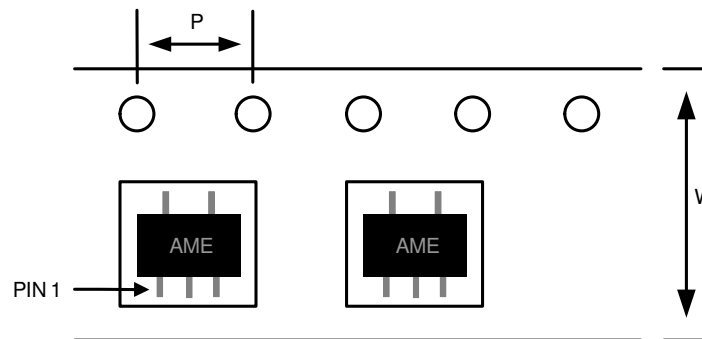
Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
SOT-143	8.0±0.1 mm	4.0±0.1 mm	3000pcs	180±1 mm

**SC-70-4**

**Carrier Tape, Number of Components Per Reel and Reel Size**

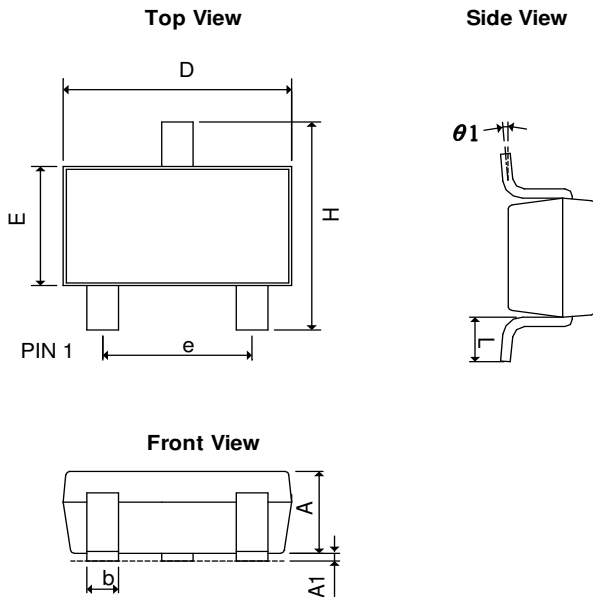
Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
SC-70-4	8.0±0.1 mm	4.0±0.1 mm	3000pcs	180±1 mm

**■ Tape and Reel Dimension (Contd.)**
**SOT-25**

**Carrier Tape, Number of Components Per Reel and Reel Size**

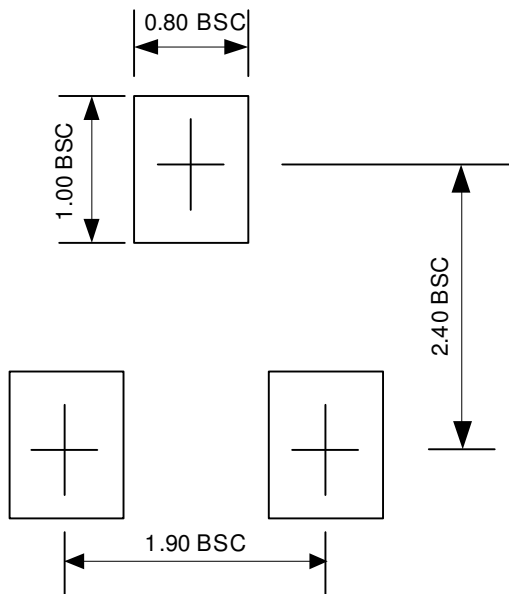
Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
SOT-25	8.0±0.1 mm	4.0±0.1 mm	3000pcs	180±1 mm

**TSOT-25A**

**Carrier Tape, Number of Components Per Reel and Reel Size**

Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
TSOT-25A	8.0±0.1 mm	4.0±0.1 mm	3000pcs	180±1 mm

**■ Package Dimension**
**SOT-23**


SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.90	1.40	0.0354	0.0551
A <sub>1</sub>	0.00	0.15	0.0000	0.0059
b	0.30	0.50	0.0118	0.0197
D	2.70	3.10	0.1063	0.1220
E	1.40	1.80	0.0551	0.0709
e	1.90 BSC		0.0748 BSC	
H	2.40	3.00	0.0945	0.1181
L	0.35BSC		0.0138 BSC	
$\theta 1$	0°	10°	0°	10°

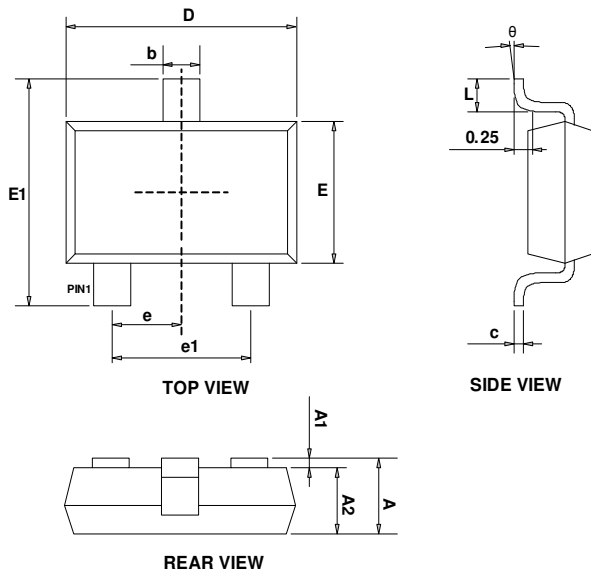
**■ Lead Pattern Drawing**

**Note:**

1. Lead pattern unit description:

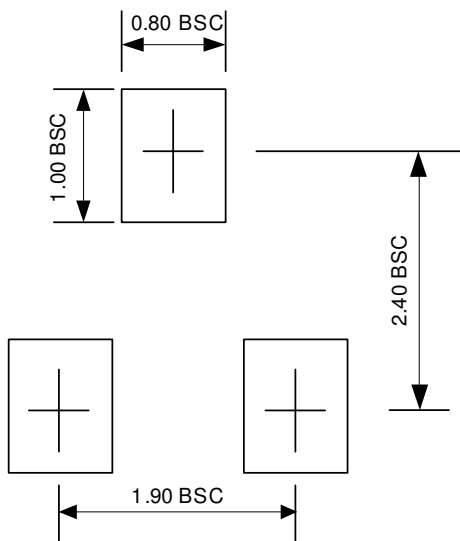
BSC: Basic. Represents theoretical exact dimension or dimension target.

2. Dimensions in Millimeters.

3. General tolerance  $\pm 0.05\text{mm}$  unless otherwise specified.

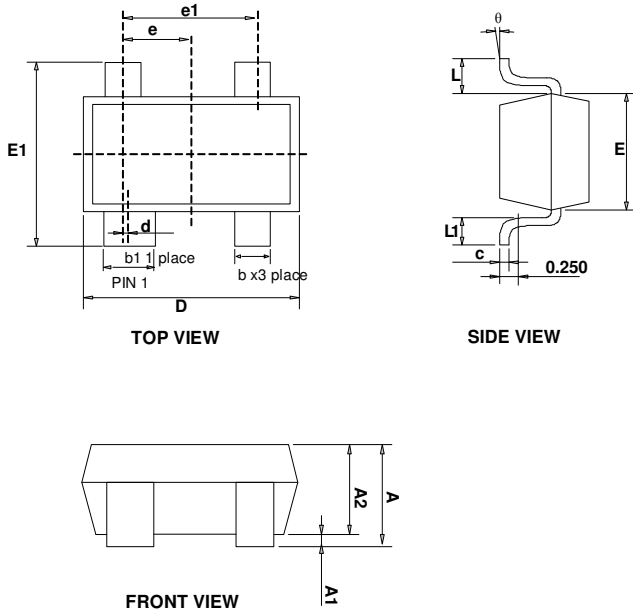
**■ Package Dimension (Contd.)**
**TSOT-23A**


SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
<b>A</b>	0.700	0.900	0.028	0.035
<b>A1</b>	0.000	0.100	0.000	0.004
<b>A2</b>	0.700	0.800	0.028	0.031
<b>b</b>	0.350	0.500	0.014	0.020
<b>c</b>	0.080	0.200	0.003	0.008
<b>D</b>	2.820	3.020	0.111	0.119
<b>E</b>	1.600	1.700	0.063	0.067
<b>E1</b>	2.650	2.950	0.104	0.116
<b>e</b>	0.95 BSC		0.037 BSC	
<b>e1</b>	1.90 BSC		0.075 BSC	
<b>L</b>	0.300	0.600	0.012	0.024
<b>θ</b>	0°	8°	0°	8°

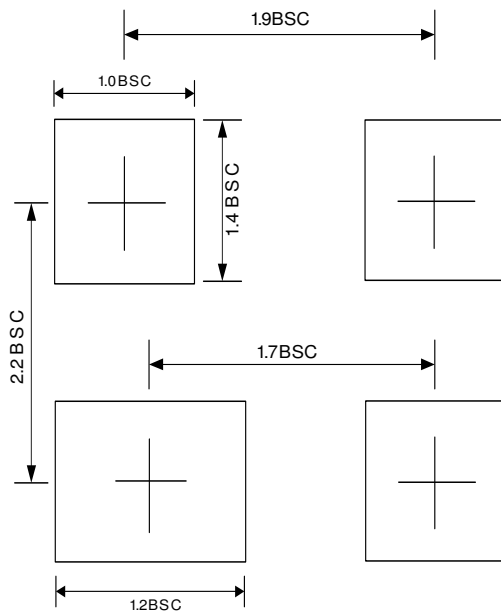
**■ Lead Pattern Drawing**

**Note:**
**1. Lead pattern unit description:**

BSC: Basic. Represents theoretical exact dimension or dimension target.

**2. Dimensions in Millimeters.**
**3. General tolerance  $\pm 0.05\text{mm}$  unless otherwise specified.**

**■ Package Dimension (Contd.)**
**SOT-143**


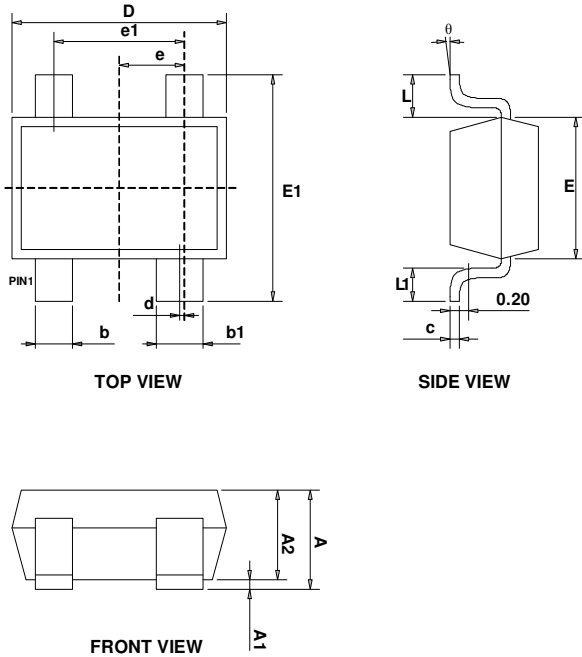
SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
<b>A</b>	0.900	1.150	0.035	0.045
<b>A1</b>	0.000	0.100	0.000	0.004
<b>A2</b>	0.900	1.050	0.035	0.041
<b>b</b>	0.300	0.500	0.012	0.020
<b>b1</b>	0.750	0.900	0.030	0.035
<b>c</b>	0.080	0.150	0.003	0.006
<b>D</b>	2.800	3.000	0.110	0.118
<b>d</b>	0.200 TYP		0.008 TYP	
<b>E</b>	1.200	1.400	0.047	0.055
<b>E1</b>	2.250	2.550	0.089	0.100
<b>e</b>	0.950 TYP		0.037 TYP	
<b>e1</b>	1.800	2.000	0.071	0.079
<b>L</b>	0.550 REF.		0.022 REF	
<b>L1</b>	0.300	0.500	0.012	0.020
<b><math>\theta</math></b>	0°	8°	0°	8°

**■ Lead Pattern Drawing**

**Note:**
**1. Lead pattern unit description:**

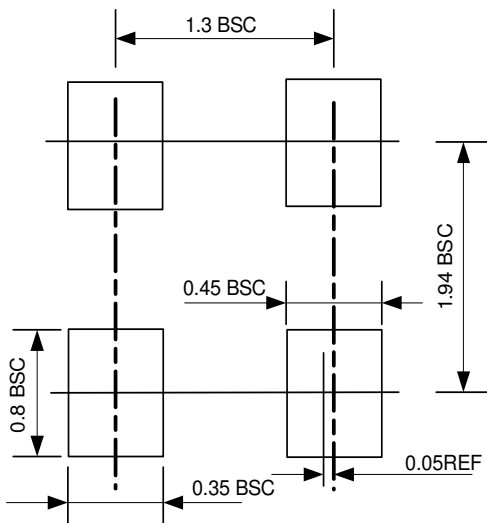
BSC: Basic. Represents theoretical exact dimension or dimension target.

**2. Dimensions in Millimeters.**
**3. General tolerance 0.05mm unless otherwise specified.**



**■ Package Dimension (Contd.)**
**SC-70-4**


SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
<b>A</b>	0.900	1.100	0.035	0.043
<b>A1</b>	0.000	0.100	0.000	0.004
<b>A2</b>	0.900	1.000	0.035	0.039
<b>b</b>	0.250	0.400	0.010	0.016
<b>b1</b>	0.350	0.500	0.014	0.020
<b>c</b>	0.080	0.150	0.003	0.006
<b>d</b>	0.050 TYP		0.002 TYP	
<b>D</b>	2.000	2.200	0.079	0.087
<b>E</b>	1.150	1.350	0.045	0.053
<b>E1</b>	2.150	2.450	0.085	0.096
<b>e</b>	0.650 TYP		0.026 TYP	
<b>e1</b>	1.200	1.400	0.047	0.055
<b>L</b>	0.525 REF		0.021 REF	
<b>L1</b>	0.260	0.460	0.010	0.018
<b>θ</b>	0°	8°	0°	8°

**■ Lead Pattern Drawing**


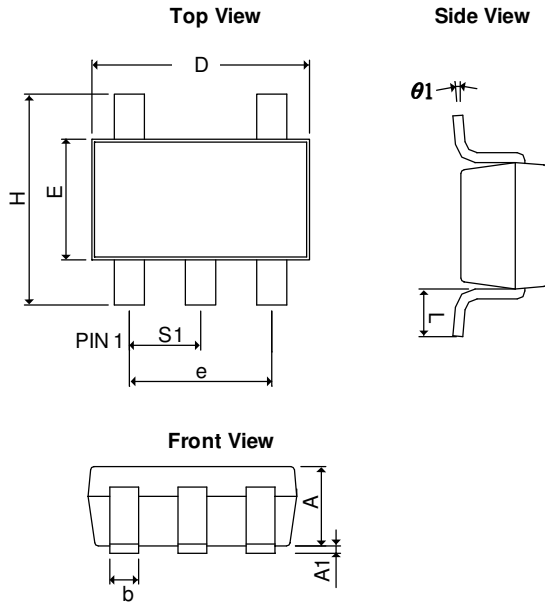
Note:

1. Lead pattern unit description:

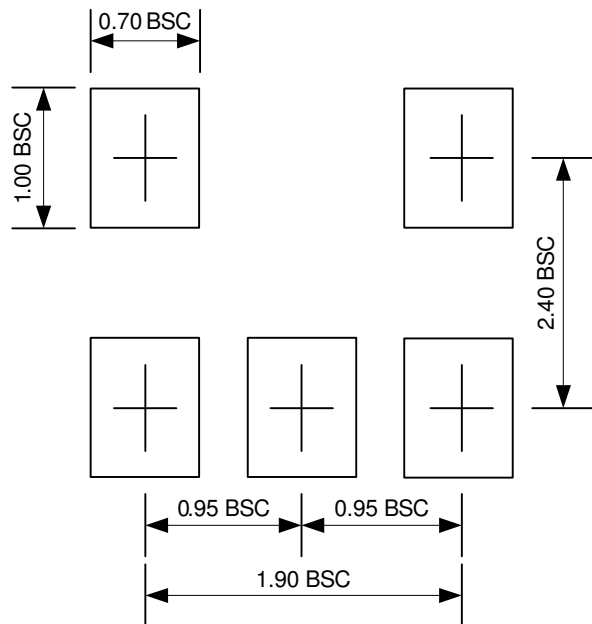
BSC: Basic. Represents theoretical exact dimension or dimension target.

2. Dimensions in Millimeters.

3. General tolerance  $\pm 0.05\text{mm}$  unless otherwise specified.

**■ Package Dimension (Contd.)**
**SOT-25**


SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.90	1.30	0.0354	0.0512
A <sub>1</sub>	0.00	0.15	0.0000	0.0059
b	0.30	0.55	0.0118	0.0217
D	2.70	3.10	0.1063	0.1220
E	1.40	1.80	0.0551	0.0709
e	1.90 BSC		0.0748 BSC	
H	2.60	3.00	0.1024	0.1181
L	0.37 BSC		0.0146 BSC	
θ1	0°	10°	0°	10°
S <sub>1</sub>	0.95 BSC		0.0374 BSC	

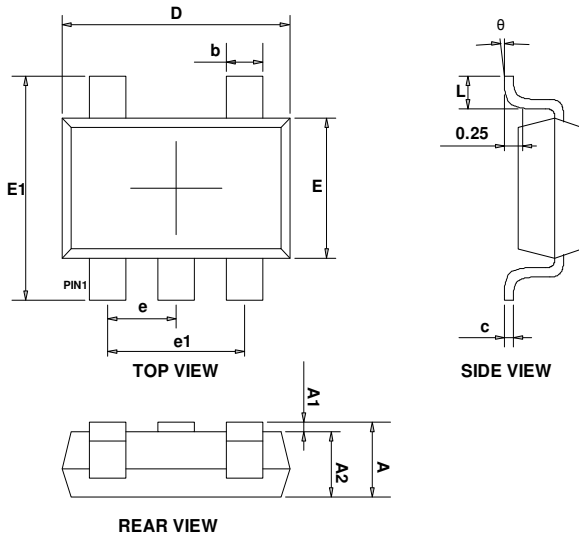
**■ Lead Pattern Drawing**

**Note:**

1. Lead pattern unit description:

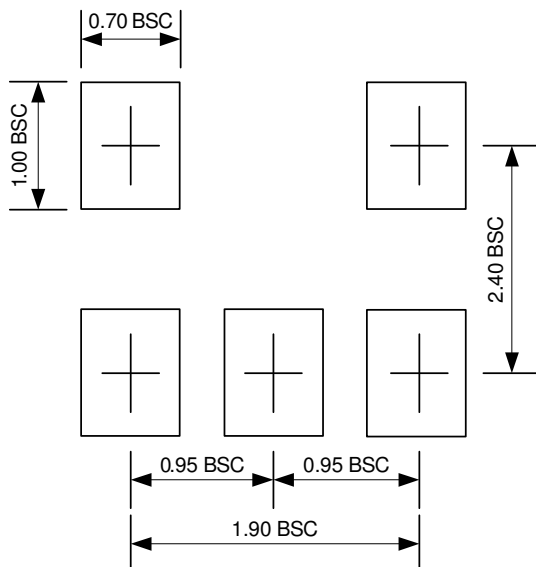
BSC: Basic. Represents theoretical exact dimension or dimension target.

2. Dimensions in Millimeters.

3. General tolerance  $\pm 0.05\text{mm}$  unless otherwise specified.

**■ Package Dimension (Contd.)**
**TSOT-25A**


SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
<b>A</b>	0.700	0.900	0.028	0.035
<b>A1</b>	0.000	0.100	0.000	0.004
<b>A2</b>	0.700	0.800	0.028	0.031
<b>b</b>	0.350	0.500	0.014	0.020
<b>c</b>	0.080	0.200	0.003	0.008
<b>D</b>	2.820	3.020	0.111	0.119
<b>E</b>	1.600	1.700	0.063	0.067
<b>E1</b>	2.650	2.950	0.104	0.116
<b>e</b>	0.95 BSC		0.037 BSC	
<b>e1</b>	1.90 BSC		0.075 BSC	
<b>L</b>	0.300	0.600	0.012	0.024
<b><math>\theta</math></b>	0°	8°	0°	8°

**■ Lead Pattern Drawing**

**Note:**

1. Lead pattern unit description:

BSC: Basic. Represents theoretical exact dimension or dimension target.

2. Dimensions in Millimeters.

3. General tolerance  $\pm 0.05\text{mm}$  unless otherwise specified.



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